

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

WARREN M. FARNWORTH

Serial No.:

Filing Date: Concurrently Herewith

Title: METHOD FOR FABRICATING ELECTRONIC ASSEMBLIES
 USING SEMI CURED CONDUCTIVE ELASTOMERIC BUMPS

Attorney Docket No.: 97-385

ASSIGNMENT:

 x Enclosed for recording

 Previously recorded

Date: _____

Reel: _____

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency, and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN, AND TRANSFER to Micron Technology, Inc. (the "Assignee"), a corporation of the State of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which will be executed by the undersigned and is entitled: **METHOD FOR FABRICATING ELECTRONIC ASSEMBLIES USING SEMI CURED CONDUCTIVE ELASTOMERIC BUMPS;** such application and all divisional, continuing, substitute, renewal, reissue, and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST, the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

PATENT

REEL: 9116 FRAME: 0839

WARRANT AND COVENANT that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney, and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining, and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives, and successors of the undersigned and extend to the successors, assigns, and nominees of the Assignee.

(Signature) Warren M. Farnworth
WARREN M. FARNWORTH

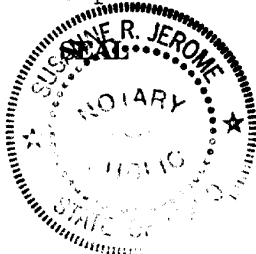
Date 4-8-98

STATE OF IDAHO

}ss.

COUNTY OF ADA

BEFORE ME, this 8th day of April, 1998, personally appeared the above named individual(s), to me known to be the person(s) who is (are) described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her (their) own free will for the purpose therein expressed.



Susanne R. Jerome
Notary or Consular Officer of the
United States of America

My Commission Expires: 3/12/2002

MICRON TECHNOLOGY, INC.

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RECORDED: 04/13/1998

REEL: 9116 FRAME: 0840